

NDC7003P

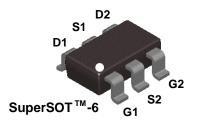
Dual P-Channel PowerTrench® MOSFET

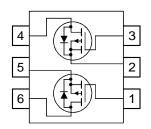
General Description

These dual P-Channel Enhancement Mode Power Field Effect Transistors are produced using Fairchild's proprietary Trench Technology. This very high density process has been designed to minimize on-state resistance, provide rugged and reliable performance and fast switching. This product is particularly suited to low voltage applications requiring a low current high side switch.

Features

- -0.34A, -60 V. $R_{DS(ON)} = 5 \Omega @ V_{GS} = -10 V$ $R_{DS(ON)} = 7 \Omega @ V_{GS} = -4.5 V$
- · Low gate charge
- · Fast switching speed
- High performance trench technology for low RDS(ON)
- SuperSOTTM -6 package: small footprint (72% smaller than standard SO-8); low profile (1mm thick)





Absolute Maximum Ratings T_A=25°C unless otherwise noted

	9 %			
Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		-60	V
V _{GSS}	Gate-Source Voltage		±20	V
I _D	Drain Current - Continuous	(Note 1a)	-0.34	А
	- Pulsed		-1	
P _D	Power Dissipation for Single Operation	(Note 1a)	0.96	W
		(Note 1b)	0.9	
		(Note 1c)	0.7	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C

Thermal Characteristics

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	130	°C/W	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	60		

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
.03P	NDC7003P	7"	8mm	3000 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Cha	racteristics		1	ı	·	
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \qquad I_{D} = -250 \mu\text{A}$	-60			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \mu\text{A}$, Referenced to 25°C		– 57		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -48 \text{ V}, V_{GS} = 0 \text{ V}$			-1	μΑ
I _{GSS}	Gate-Body Leakage,	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
On Cha	racteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu\text{A}$	-1	-1.9	-3.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \mu\text{A}$, Referenced to 25°C		3.2		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$V_{GS} = -10 \text{ V}, \qquad I_D = -0.34 \text{ A}$ $V_{GS} = -4.5 \text{ V}, \qquad I_D = -0.25 \text{ A}$ $V_{GS} = -10 \text{ V}, I_D = -0.34 \text{ A}, T_J = 125 ^{\circ}\text{C}$		1.2 1.5 1.9	5 7.5 10	Ω
I _{D(on)}	On-State Drain Current	$V_{GS} = -10 \text{ V}$ $V_{DS} = -10 \text{ V}$	-1			Α
g FS	Forward Transconductance	$V_{DS} = -10 \text{ V}, \qquad I_{D} = -0.34 \text{ A}$		700		mS
Dvnami	c Characteristics				•	
C _{iss}	Input Capacitance	$V_{DS} = -25 \text{ V}, V_{GS} = 0 \text{ V},$		66		pF
Coss	Output Capacitance	f = 1.0 MHz		13		pF
C _{rss}	Reverse Transfer Capacitance			6		pF
R _G	Gate Resistance	$V_{GS} = 15 \text{mV}, \qquad f = 1.0 \text{ MHz}$		11.2		Ω
Switchi	ng Characteristics (Note 2)					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = -25 \text{ V}, \qquad I_{D} = -1 \text{ A},$		3.2	6.4	ns
t _r	Turn-On Rise Time	$V_{GS} = -10 \text{ V}, \qquad R_{GEN} = 6 \Omega$		10	20	ns
t _{d(off)}	Turn-Off Delay Time			8	16	ns
t _f	Turn-Off Fall Time			1	2	ns
Q _g	Total Gate Charge	$V_{DS} = -25 \text{ V}, \qquad I_{D} = -0.34 \text{ A},$		1.6	2.2	nC
Q_{gs}	Gate-Source Charge	$V_{GS} = -10 \text{ V}$		0.3		nC
Q _{gd}	Gate-Drain Charge			0.3		nC
Drain-S	Source Diode Characteristics	and Maximum Ratings	-	•	•	
Is	Maximum Continuous Drain-Sourc	<u>-</u>			-0.34	Α
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \qquad I_S = -0.34 \text{ A(Note 2)}$		-0.8	-1.4	V

Notes

1. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.



a) 130 °C/W when mounted on a 0.125 in² pad of 2 oz. copper.



b) 140°C/W when mounted on a .005 in² pad of 2 oz copper



c) 180°C/W when mounted on a minimum pad.

Scale 1:1 on letter size paper

2. Pulse Test: Pulse Width < $300\mu s$, Duty Cycle < 2.0%

Typical Characteristics

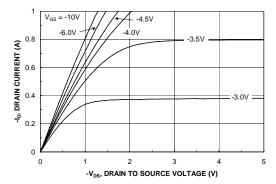


Figure 1. On-Region Characteristics.

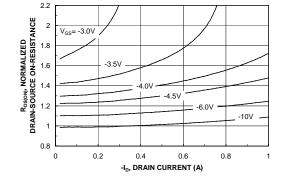


Figure 2. On-Resistance Variation with Drain Current and Gate Voltage.

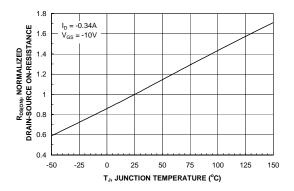


Figure 3. On-Resistance Variation with Temperature.

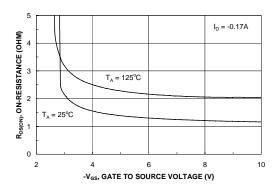


Figure 4. On-Resistance Variation with Gate-to-Source Voltage.

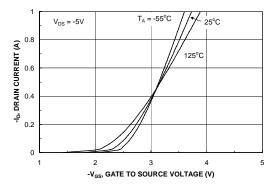


Figure 5. Transfer Characteristics.

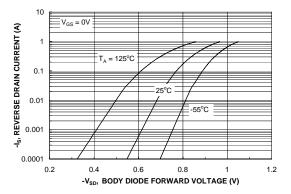
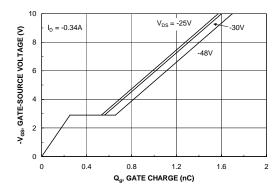


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.

Typical Characteristics



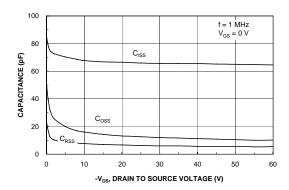
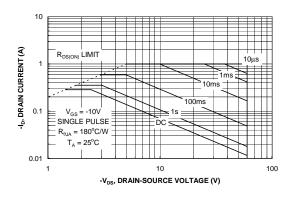


Figure 7. Gate Charge Characteristics.





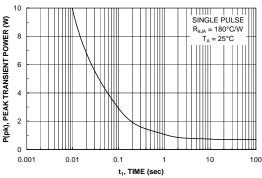


Figure 9. Maximum Safe Operating Area.



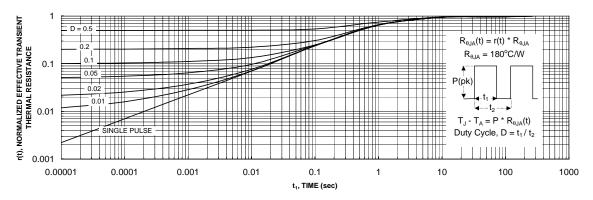


Figure 11. Transient Thermal Response Curve.

Thermal characterization performed using the conditions described in Note 1c. Transient themal response will change depending on the circuit board design.

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